

# **Small Signal Product**

# Hermetically Sealed Glass Fast Switching Schottky Barrier Diodes

#### **FEATURES**

- Low forward voltage drop
- Ideal for automated placement
- Hermetically sealed glass
- Compression bonded construction
- All external surfaces are corrosion resistant and leads are readily solderable
- Solder hot dip tin (Sn) lead finish









#### **MECHANICAL DATA**

- Polarity: Indicated by black cathode band

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Power Dissipation	P <sub>D</sub>	200	mW		
Repetitive Peak Reverse Voltage	$V_{RRM}$	30	V		
Maximum DC Blocking Voltage	V <sub>R</sub>	30	V		
Average Forward Rectified Current	I <sub>F(AV)</sub>	200	mA		
Peak Forward Surge Current	I <sub>FSM</sub>	4	A		
Operating Junction Temperature	T <sub>J</sub>	125	°C		
Storage Temperature Range	T <sub>STG</sub>	-65 to +125	°C		

PAR	SYMBOL	MIN	TYP	MAX	UNIT	
Breakdown Voltage	I <sub>R</sub> =10μA	B <sub>V</sub>	30			V
Reverse Leakage Current	V <sub>R</sub> =25V	I <sub>R</sub>			2	μA
Forward Voltage	I <sub>F</sub> =0.1mA				0.24	
	I <sub>F</sub> =1.0mA				0.32	
	I <sub>F</sub> =10mA	V <sub>F</sub>			0.40	V
	I <sub>F</sub> =30mA				0.50	
	I <sub>F</sub> =100mA				0.80	
Reverse Recovery Time	(Note 1)	t <sub>rr</sub>		5		ns
Junction Capacitance	V <sub>R</sub> =1V, f=1.0MHz	CJ			10	pF

Note 1: Reverse recovery test conditions :  $I_F = I_R = 10 \text{mA}$ ,  $R_L = 100 \Omega$ ,  $I_{RR} = 1 \text{mA}$ 

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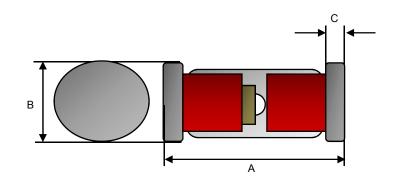
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ORDERING INFORMATION					
PART NO.	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
	SUFFIX (Note 1)	PACKING CODE	SUFFIX		PACKING
BAS85	-XX	L0	G	MINI MELF	10K / 13" Reel
BA303	-xx	L1			2.5K / 7" Reel

Note 1: Part No. Suffix "-xx " would be used for special requirement

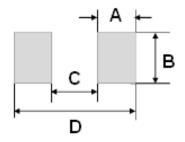
EXAMPLE					
PREFERRED P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
BAS85 L0G	BAS85		L0	G	Multiple manufacture source Halogen free
BAS85-L0 L0G	BAS85	-L0	L0	G	Define manufacture source Halogen free

## **PACKAGE OUTLINE DIMENSION**



DIM.	Unit (mm)		Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	3.30	3.70	0.130	0.146	
В	1.40	1.60	0.055	0.063	
С	0.20	0.50	0.008	0.020	

# **SUGGEST PAD LAYOUT**



DIM.	Unit (mm)	Unit (inch)	
DIIVI.	Тур.	Тур.	
Α	1.25	0.049	
В	2.00	0.079	
С	2.50	0.098	
D	5.00	0.197	



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